

Scalability and Interconnect Technologies

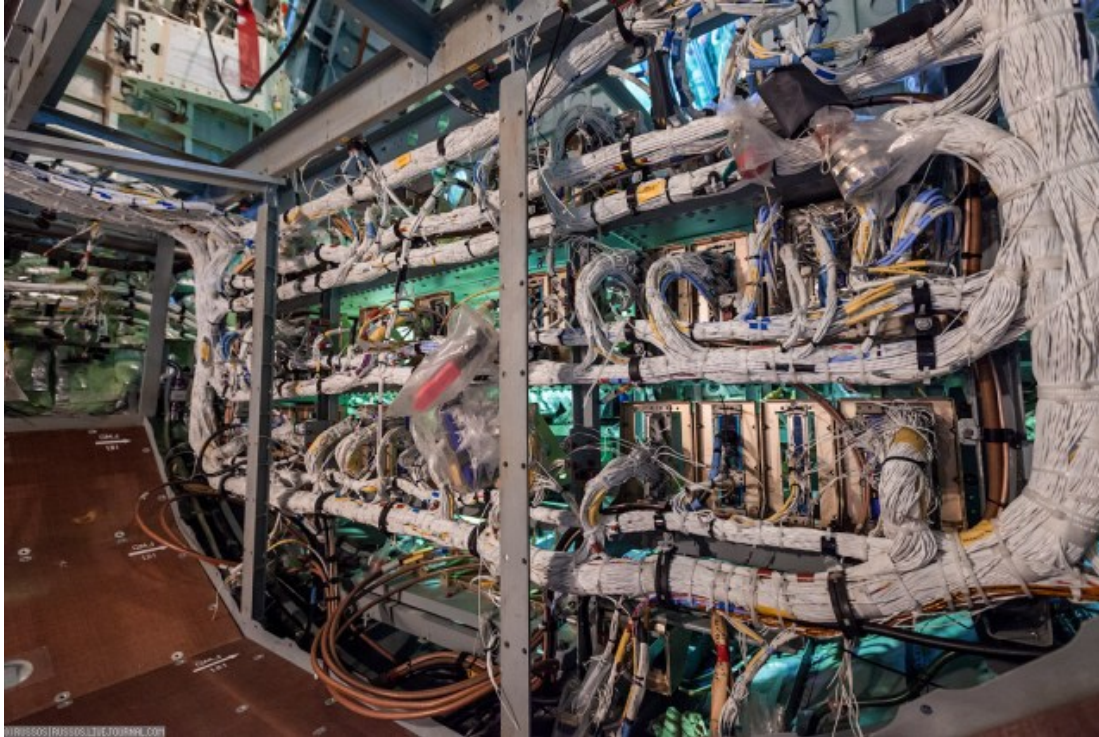
Gerald Persaud, VP Business Development

Embedded Tech Trends

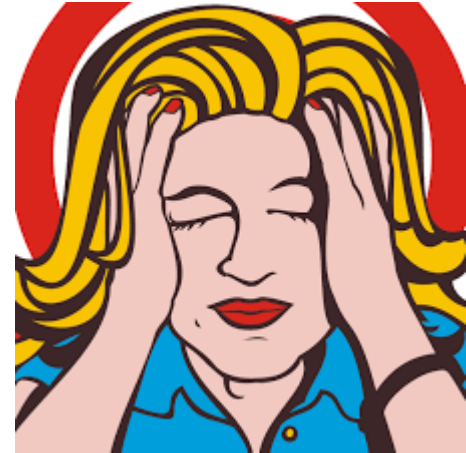
Austin, Tx

January 22-23, 2018

Scalability, is it really a concern?

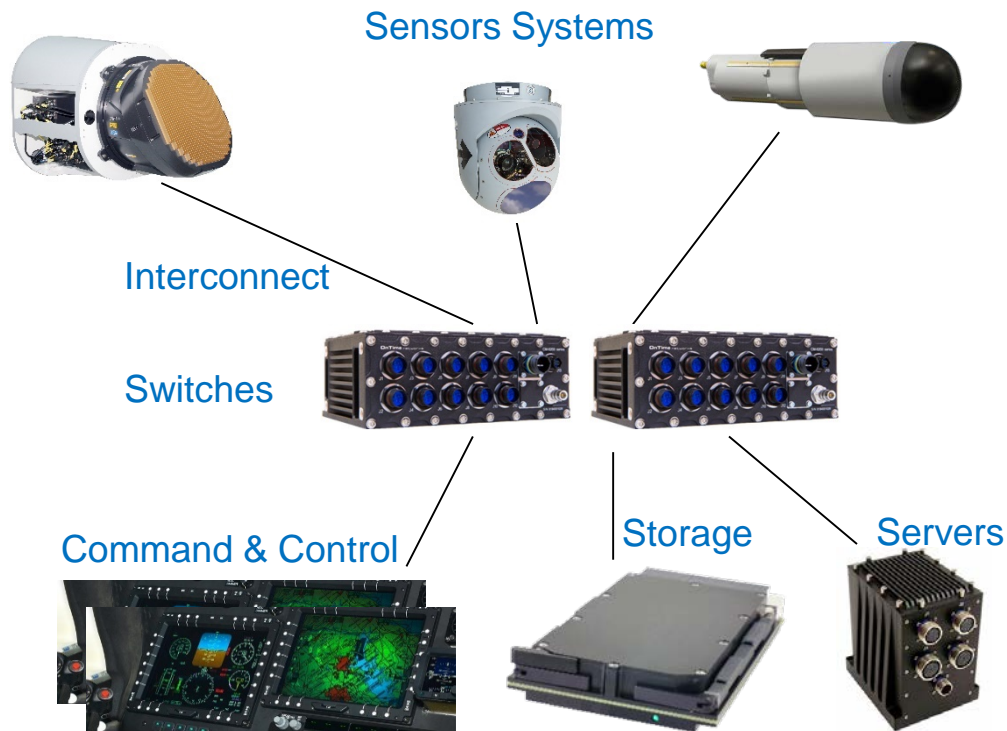


Only if you want to change



Scalability Design Considerations

- **Change complexity**
 - Interconnect → difficult
 - Computing → relatively Simple
- **Life cost profile → pay now or pay later**
 - Upgrades, maintenance, installation
- **Infrastructure sizing**
 - Interconnect bandwidth
 - Cooling
 - Power and distribution
- **Open standards (HOST, SOSA, FACE..)**
 - Lower cost, faster tech insertion
- **Modular vs integrated → Modular overhead**
- **Fast (changing) technologies**
 - Can they be deployed before they are obsolete?



Fast Technologies – Disruptive!!

- Deep Neural Networks (DNN) → SMART rules
- Augmented/Virtual Reality → Manned and unmanned advantages
- Graphic processors → Powers SMART, AR and VR
- Solid state memory → Knowledge in smaller chips
- Hi-res sensors (Cameras, radar, Lidar, ...) → See more do more
- Hi-res displays (2K, 4K, 8K) → I can see!
- **OPTICAL TRANSCEIVERS → UNENCUMBERED BANDWIDTH FOR ALL TECHNOLOGIES**



Optical Interconnects, the bridge to Fast

Optical Interconnect Overview

Multi Mode (MM) Transmission

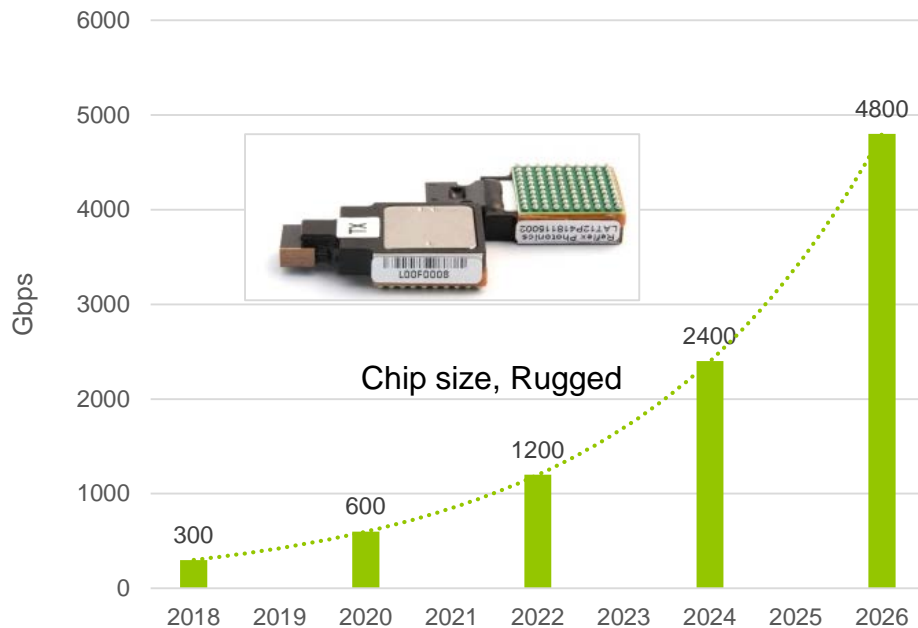
- Reach less than 300 m
- Lowest cost transceivers
- Easy to work with
- Rugged transceivers
- -55 °C to 125 °C without active cooling
- Least SWaP
- Suitable for harsh environments

Single Mode (SM) Transmission

- Reach greater than 2 km
- Relatively expensive transceiver
- Difficult to work with due to high precision alignment
- Precise wavelength control needed over temperature.
- Operating temperature limited to 0 °C to 70 °C
- Suitable for controlled environment
- DWDM can support more than 160 wavelengths

Multi-Mode is the choice for Harsh Environments

Rugged Optical Transceiver Bandwidth Scale



- 12 to 24 fibers per chip 2018
- 50G to 300G @ 12.5G/fiber 2018
- 600G @ 25G/fiber 2020
- 1200G @ 50G/fiber (PAM4) 2022
- 2400G @ 100G/fiber (SWDM) 2024
- 4800G @ 200G/fiber (SWDM) 2026

Challenge: Reducing power as BW Scales

Transceiver Product Range

LightSPACE



- Ultra Rugged
- Space Qualified
- RAD HARD

LightABLE



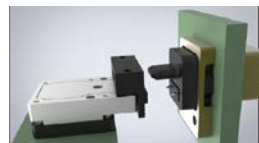
- Rugged
- Mil Qualified
- -45 °C to 100 °C

LightVISION



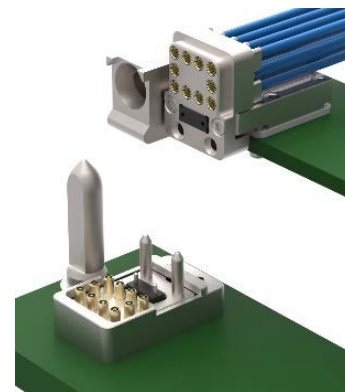
- Industrial
- -40 °C to 85 °C

LightCONEX



- Blind mate
- Rugged
- VITA 66.5

LightCONEX Combo



- Blind mate
- Optical/RF Combo
- VITA 66.5

QSFP+/QSFP28



- Pluggable
- Industry standard
- Commercial temp

SNAP12



- MPO bulk head mount
- Industry standard

Many Options to Scale BW

Optical Transceiver Applications

Digital RADAR



Hi Res Cameras



FMC Boards



Optical Switches



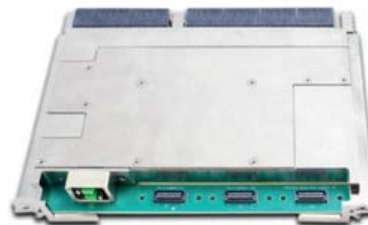
High Performance Computers



Media Converters



VPX Plug in Modules



Optical Backplane



High BW, Low Latency, Small SWaP

Takeaways

- **Fast technologies creating uneven advantage.**
- **Race to AI dominance is fierce.**
- **System must scale faster than ever to stay viable.**
- **Optical Interconnects is the most scalable technology for fast upgrades and SWaP.**

For more information

- <http://reflexphotonics.com/>

Thank You

